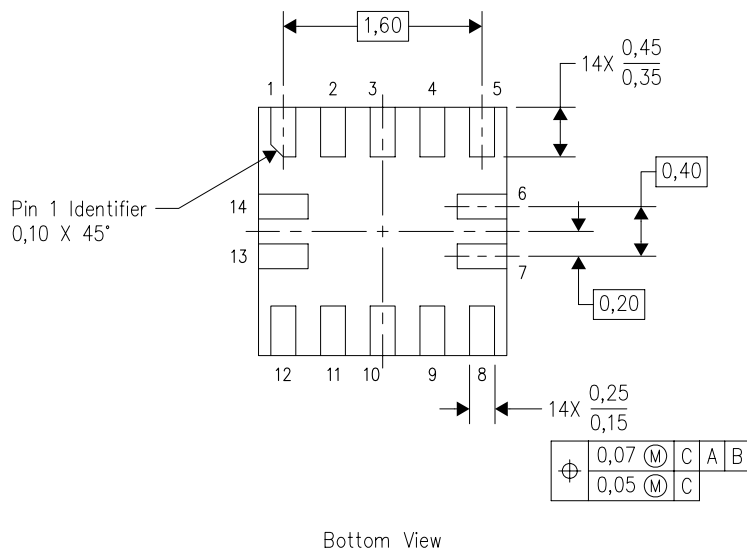
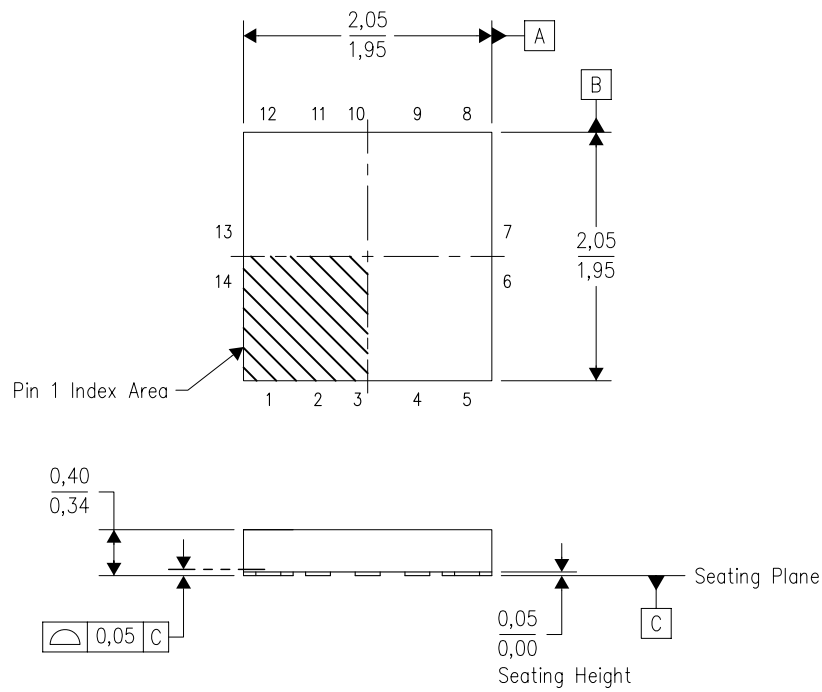


RUC (S-PX2QFN-N14)

PLASTIC QUAD FLATPACK NO-LEAD



Bottom View

4208447/C 08/2008

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-lead) package configuration.
 - D. This package complies to JEDEC MO-288 variation X2GFE.

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